Please read this notice before using the TAIYO YUDEN products.

REMINDERS

Product Information in this Catalog

Product information in this catalog is as of October 2021. All of the contents specified herein and production status of the products listed in this catalog are subject to change without notice due to technical improvement of our products, etc. Therefore, please check for the latest information carefully before practical application or use of our products.

Please note that TAIYO YUDEN shall not be in any way responsible for any damages and defects in products or equipment incorporating our products, which are caused under the conditions other than those specified in this catalog or individual product specification sheets.

Approval of Product Specifications

Please contact TAIYO YUDEN for further details of product specifications as the individual product specification sheets are available. When using our products, please be sure to approve our product specifications or make a written agreement on the product specification with TAIYO YUDEN in advance.

Pre-Evaluation in the Actual Equipment and Conditions

Please conduct validation and verification of our products in actual conditions of mounting and operating environment before using our products.

Safety Design

When using our products for high safety and/or reliability-required equipment or circuits, please fully perform safety and/or reliability evaluation. In addition, please install (i) systems equipped with a protection circuit and a protection device and/or (ii) systems equipped with a redundant circuit or other system to prevent an unsafe status in the event of a single fault for a failsafe design to ensure safety.

Intellectual Property Rights

Information contained in this catalog is intended to convey examples of typical performances and/or applications of our products and is not intended to make any warranty with respect to the intellectual property rights or any other related rights of TAIYO YUDEN or any third parties nor grant any license under such rights.

Limited Warranty

Please note that the scope of warranty for our products is limited to the delivered our products themselves conforming to the product specifications specified in the individual product specification sheets, and TAIYO YUDEN shall not be in any way responsible for any damages resulting from a failure or defect in our products. Notwithstanding the foregoing, if there is a written agreement (e.g., supply and purchase agreement, quality assurance agreement) signed by TAIYO YUDEN and your company, TAIYO YUDEN will warrant our products in accordance with such agreement, provided, however, that our products shall be used for general-purpose and standard use in the equipment specified in this catalog or the individual product specification sheets.

TAIYO YUDEN's Official Sales Channel

The contents of this catalog are applicable to our products which are purchased from our sales offices or authorized distributors (hereinafter "TAIYO YUDEN's official sales channel"). Please note that the contents of this catalog are not applicable to our products purchased from any seller other than TAIYO YUDEN's official sales channel.

Caution for Export

Some of our products listed in this catalog may require specific procedures for export according to "U.S. Export Administration Regulations", "Foreign Exchange and Foreign Trade Control Law" of Japan, and other applicable regulations. Should you have any questions on this matter, please contact our sales staff.

Limited Application

1. Equipment Intended for Use

The products listed in this catalog are intended for general-purpose and standard use in general electronic equipment for consumer (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment including, without limitation, mobile phone, and PC) and other equipment specified in this catalog or the individual product specification sheets, or the equipment approved separately by TAIYO YUDEN.

TAIYO YUDEN has the product series intended for use in the following equipment. Therefore, when using our products for these equipment, please check available applications specified in this catalog or the individual product specification sheets and use the corresponding products.

Application	Product Series		Quality Orada *3
Application	Equipment *1	Category (Part Number Code *2)	Quality Grade [*] 3
Automotive	Automotive Electronic Equipment (POWERTRAIN, SAFETY)	A	1
Automotive	Automotive Electronic Equipment (BODY & CHASSIS, INFOTAINMENT)	С	2
Industrial	Telecommunications Infrastructure and Industrial Equipment	В	2
Medical	Medical Devices classified as GHTF Class C (Japan Class III)	М	2
wedical	Medical Devices classified as GHTF Classes A or B (Japan Classes I or II)	L	3
Consumer	General Electronic Equipment	S	3

*Notes: 1. Based on the general specifications required for electronic components for such equipment, which are recognized by TAIYO YUDEN, the use of each product series for the equipment is recommended. Please be sure to contact TAIYO YUDEN before using our products for equipment other than those covered by the product series.
2. On each of our part number, the 2nd code from the left is a code indicating the "Category" as shown in the above table. For details,

Please check the explanatory materials regarding the part numbering system of each of our products.
 Each product series is assigned a "Quality Grade" from 1 to 3 in order of higher quality. Please do not incorporate a product into any equipment with a higher Quality Grade than the Quality Grade of such product without the prior written consent of TAIYO YUDEN.

2. Equipment Requiring Inquiry

Please be sure to contact TAIYO YUDEN for further information before using the products listed in this catalog for the following equipment (excluding intended equipment as specified in this catalog or the individual product specification sheets) which may cause loss of human life, bodily injury, serious property damage and/or serious public impact due to a failure or defect of the products and/or malfunction attributed thereto.

(1) Transportation equipment (automotive powertrain control system, train control system, and ship control system, etc.)

(2) Traffic signal equipment

- (3) Disaster prevention equipment, crime prevention equipment
- (4) Medical devices classified as GHTF Class C (Japan Class III)
- (5) Highly public information network equipment, data-processing equipment (telephone exchange, and base station, etc.)
- (6) Any other equipment requiring high levels of quality and/or reliability equal to the equipment listed above

3. Equipment Prohibited for Use

Please do not incorporate our products into the following equipment requiring extremely high levels of safety and/or reliability. (1) Aerospace equipment (artificial satellite, rocket, etc.)

- (2) Aviation equipment *1
- (3) Medical devices classified as GHTF Class D (Japan Class IV), implantable medical devices *2
- (4) Power generation control equipment (nuclear power, hydroelectric power, thermal power plant control system, etc.)
- (5) Undersea equipment (submarine repeating equipment, etc.)
- (6) Military equipment

(7) Any other equipment requiring extremely high levels of safety and/or reliability equal to the equipment listed above

- *Notes:1. There is a possibility that our products can be used only for aviation equipment that does not directly affect the safe operation of aircraft (e.g., in-flight entertainment, cabin light, electric seat, cooking equipment) if such use meets requirements specified separately by TAIYO YUDEN. Please be sure to contact TAIYO YUDEN for further information before using our products for such aviation equipment.
 - 2. Implantable medical devices contain not only internal unit which is implanted in a body, but also external unit which is connected to the internal unit.

4. Limitation of Liability

Please note that unless you obtain prior written consent of TAIYO YUDEN, TAIYO YUDEN shall not be in any way responsible for any damages incurred by you or third parties arising from use of the products listed in this catalog for any equipment that is not intended for use by TAIYO YUDEN, or any equipment requiring inquiry to TAIYO YUDEN or prohibited for use by TAIYO YUDEN as described above.

WIRELESS MODULE

Our recommended Line Up of *Bluetooth*[®] and WLAN Modules

For Smartphone Peripheral & IoT Solution



XAs this catalog includes some Wireless Modules under development, the specifications of such Modules are subjects to change without prior notice. Evaluation Board & Kit for each module is avarable. And development tools for combine with sensors is avarable. For the latest information, please visit our web site at hppt://www.ty-top.com/ or feel free to contact our sales department.

*The Bluetooth[®] word mark and logos are owned by the Bluetooth SIG, Inc. and any use of such marks by TAIYO YUDEN CO., LTD. is under license. Other trademarks and trade names are those of their respective owners.

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					F	unctio	on								I/F					dule pe	т	уре а	pprov	val	
Part number	BLE	BT Classic	ANT	NFC	802.11a	802.11b	802.11g	802.11n	802.11ac	802.15.4 (Thread)	802.15.4g	UART	USB	PCM	IdS	12C	12S	SDIO	SMD	Antenna	Japan	FCC	ISED	GE	Remark
EYSQBNZUC	0		0∎	0						0		0	0		0	0	0		0	0	0	0	0	0*	Dual CPU, 32k X'tal、1M Flash、512K RAM、 BT5.3、Wide Temp.
EYSKBNUWB-VX	0											0	0		0				0	0	0	0	0	0*	TY's APP、32k X'tal、BT5
EYSKJNAWB-VX	0											0							0	0	0	0	0	0*	TY's APP、BT5
EYSKBNZWB	0		O△	0						0		0	0		0	0	0		0	0	0	0	0	0*	32k X'tal、1M Flash、256K RAM、BT5(Full)
EYSKDNZWB	0		O△	0						0		0	0		0	0	0		0	0	0	0	0	0*	High Performance Antenna、1M Flash、256K RAM、BT5(Full)
EYSKJNZWB	0		O△	0						0		0			0	0	0		0	0	0	0	0	0*	1M Flash、256K RAM、BT5(Full)
EYSPBNZUA	0		O△	0						0		0	0		0	0	0		0	0	0	0	0	0*	32k X'tal、512K Flash、128K RAM、BT5.2、Wide Temp.
EYSPDNZUA	0		O△	0						0		0	0		0	0	0		0	0	0	0	0	0*	High Performance Antenna、512K Flash、128K RAM、BT5.3、Wide Temp.
EYSPJNZUA	0		O△	0						0		0			0	0	0		0	0	0	0	0	0*	512K Flash、128K RAM、BT5.3、Wide Temp.
EYSHCNZWZ	0		0*	0								0			0	0	0		0	0	0	0	0	0**	32k X'tal、512K Flash、64K RAM、BT5
EYSHJNZWZ	0		0*	0								0			0	0	0		0	0	0	0	0	0**	512K Flash、64K RAM、BT5
EYSHSNZWZ	0		0*	0								0			0	0	0		0	0	0	0	0	0**	512K Flash、64K RAM、BT5
EYSRCNZUY	0		O△							0		0	0		0	0			0	0	0	0	0	0*	32k X'tal、256K Flash、32K RAM、BT5.3、Wide Temp.
EYSRSNZUY	0		O△							0		0	0		0	0			0	0	0	0	0	0*	256K Flash、32K RAM、BT5.3、Wide Temp.
EYSNCNZWW	0		0▲							0		0			0	0			0	0	0	0	0	0*	32k X'tal、192K Flash、24K RAM、BT5.2
EYSNSNZWW	0		0*							0		0			0	0			0	0	0	0	0	0*	192K Flash、24K RAM、BT5.2
EYSLCNZWW	0		0^									0			0	0			0	0	0	0	0	0*	32k X'tal、192K Flash、24K RAM、BT5
EYSLSNZWW	0		0^									0			0	0			0	0	0	0	0	0*	192K Flash、24K RAM、BT5
EYSGCNAWY-VX	0											0							0	0	0	0	0	0*	TY's APP、32k X'tal
EYSGJNAWY-VX	0											0							0	0	0	0	0	0*	TY's APP
EYSGCNZWY	0											0			0	0			0	0	0	0	0	0*	32k X'tal、256K Flash、32K RAM
EYSGCNZXX	0											0			0	0			0	0	0	0	0	0*	32k X'tal、256K Flash、16K RAM
EYSGJNZWY	0											0			0	0			0	0	0	0	0	0*	256K Flash、32K RAM
EYSGJNZXX	0											0			0	0			0	0	0	0	0	0*	256K Flash、16K RAM
EYAGJNZXX	0		0									0			0	0			0	0	0	0	0	0*	256K Flash、32K RAM
EYSGCCAXW	0	0										0							0	0	0	0	0	0*	HCI Firmware
EYSGCCSXW	0	0											0						0	0	0	0	0	0*	HCI Firmware

Bluetooth® low energy & ANT Module, Bluetooth® Dual Mode Module

▲ Softdevice S340
 ▲ Softdevice S313

♦ Softdevice S312

WLAN + MCU Modu	le																								
					F	unctio	on								I/F				Module type Type approval			pprov	val		
Part number	BLE	BT Classic	ANT	NFC	802.11a	802.11b	802.11g	802.11n	802.11ac	802.15.4 (Thread)	802.15.4g	UART	USB	PCM	IdS	12C	12S	OIDS	SMD	Antenna	Japan	FCC	ISED	CE	Remark
WYSACVLAY-XZ						0	0	0				0			0				0	0	0	0	0	0*	w/Cortex M4F、4MB-Flash ROM
			* ETSI EN 300 328 v2.2.2 Conducted Test Report Available											ETS	[EN 3	300 32	28 v2.	2.2 C	onduc	ted 7	Fest F	Repor	t Ava	ilable	

WLAN +	Bluetooth®	Combo	Module	

					F	unctio	on								I/F				Moo ty	dule pe	T	ype a	pproval		
Part number	BLE	BT Classic	ANT	NFC	802.11a	802.11b	802.11g	802.11n	802.11ac	802.15.4 (Thread)	ů.	UART	BSU	PCM	IdS	I2C	12S	OIGS	DMS	Antenna	Japan	FCC	ISED	CE	Remark
WYSAGVDXG	0	0			0	0	0	0	0					0				0	0	0	0	0	0	0*	Dual Band Antenna(Chip)
WYSEGVDXG	0	0			0	0	0	0	0					0				0	0	∆**	0	0	0		RF Connector(Limited antenna)
WYSBHVGXG	0	0			0	0	0	0	0					0				0	0						
* ETS									SI EN	300	328 8	ETS	I EN 3	301 8	93 v2	.2.2 0	Condu	cted [·]	Test	Repor	t Ava	ailable			

* ETSI EN 300 328 & ETSI EN 301 893 v2.2.2 Con ** Embedded RF Connector for Limited Antenna

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Part number	nergy & ANT Module, Bluetooth® Dual Mode M Function	Module type	I/F	Feature	Outline [mm] (Height : Maximum)
EYSQBNZUC	Bluetooth® low energy v5.3	BLE Central and Peripheral	UART	w/CPU (Cortex M33)	10.0 x 15.4 x 2.0
(nRF5340)	& 802.15.4 (Thread)	SMD type	USB	32kHz Crystal	
	& NFC-A Type-2		I2C	Antenna	
	Dual CPU Embedded(Applicaton & Network)		SPI	1MB Flash(AP),256KB Flash(Network)	
		I2S 512KB RAM(AP), 64KB RAM(Net			
			PDM	FCC/ISED/Japan certified	
			46 GPIO	ETSI EN 300 328 v2.2.2 Conducted Test	
				Report Available	
EYSKBNUWB-VX	Bluetooth® low energy v5.0	BLE Central and Peripheral	UART	w/CPU (Cortex M4F)	10.0 x 15.4 x 2.0
(nRF52840)		SMD type	USB	32kHz Crystal	
		TAIYO YUDEN Software Embedded	SPI	Antenna	
				FCC/ISED/Japan certified	
				ETSI EN 300 328 v2.2.2 Conducted Test	
				Report Available	
EYSKJNAWB-VX	Bluetooth® low energy v5.0	BLE Central and Peripheral	UART	w/CPU (Cortex M4F)	5.1 x 11.3 x 1.3
(nRF52840)		SMD type		Antenna	
		TAIYO YUDEN Software Embedded		FCC/ISED/Japan certified	
				ETSI EN 300 328 v2.2.2 Conducted Test	
				Report Available	
EYSKBNZWB	Bluetooth® low energy v5.0(Full)	BLE Central and Peripheral	UART	w/CPU (Cortex M4F)	10.0 x 15.4 x 2.0
(nRF52840)	& 802.15.4 (Thread)	SMD type	USB	32kHz Crystal	A A 21
	& NFC-A Type-2		I2C	Antenna	
	S 11 0 // 1990 L		SPI	1MB Flash	
			12S	256KB RAM	
			PDM	FCC/ISED/Japan certified	
			46 GPIO	ETSI EN 300 328 v2.2.2 Conducted Test	
			LLADT	Report Available	
YSKDNZWB	Bluetooth® low energy v5.0(Full)	BLE Central and Peripheral	UART	w/CPU (Cortex M4F)	9.6 x 12.9 x 1.4
(nRF52840)	& 802.15.4 (Thread)	SMD type	USB	Antenna	
	& NFC-A Type-2	High Performance Antenna Type	I2C	1MB Flash	
			SPI	256KB RAM	
			I2S	FCC/ISED/Japan certified	
			PDM	ETSI EN 300 328 v2.2.2 Conducted Test	0
			19 GPIO	Report Available	h
EYSKJNZWB	Bluetooth® low energy v5.0(Full)	BLE Central and Peripheral	UART	w/CPU (Cortex M4F)	5.1 x 11.3 x 1.3
(nRF52840)	& 802.15.4 (Thread)	SMD type	I2C	Antenna	
	& NFC-A Type-2		SPI	1MB Flash	
			125	256KB RAM	
					- 명주
			PDM	FCC/ISED/Japan certified	
			15 GPIO	ETSI EN 300 328 v2.2.2 Conducted Test	
EYSPBNZUA	Bluetooth® low energy v5.2	BLE Central and Peripheral	UART	Report Available w/CPU(Cortex M4F)	10.0 x 15.4 x 2.0
(nRF52833)	& 802.15.4 (Thread)	SMD type	USB	32kHz Crystal	10.0 X 10.1 X 2.0
(1111 52055)		Змр туре			
	& NFC-A Type-2		I2C	Antenna	
			SPI	512KB Flash	
			I2S	128KB RAM	
			PDM	FCC/ISED/Japan certified	
			40 GPIO	ETSI EN 300 328 v2.2.2 Conducted Test	
			40 GPI0	Report Available	
				Operation temperature:-40°C~105°C	
EYSPDNZUA	Bluetooth® low energy v5.3	BLE Central and Peripheral	UART	w/CPU (Cortex M4F)	9.6 x 12.9 x 1.4
(nRF52833)	& 802.15.4 (Thread)	SMD type	USB	Antenna	• <u>••</u>
	& NFC-A Type-2	High Performance Antenna Type	I2C	512KB Flash	ren f
			SPI	128KB RAM	
			I2S	FCC/ISED/Japan certified	
			PDM	ETSI EN 300 328 v2.2.2 Conducted Test	
			19 GPIO	Report Available	
				Operation temperature: $-40^{\circ}C \sim 105^{\circ}C$	
EYSPJNZUA	Bluetooth® low energy v5.3	BLE Central and Peripheral	UART	w/CPU (Cortex M4F)	5.1 x 11.3 x 1.3
(nRF52833)	& 802.15.4 (Thread)	SMD type	I2C	Antenna	r A
	& NFC-A Type-2		SPI I2S	512KB Flash 128KB RAM	
			I2S PDM	FCC/ISED/Japan certified	
			15 GPIO	ETSI EN 300 328 v2.2.2 Conducted Test	87 - 1
				Report Available	
				Operation temperature:-40°C~105°C	
	Bluetooth® low energy v5.0	BLE Central and Peripheral	UART	w/CPU (Cortex M4F)	9.6 x 12.9 x 2.0
	& NFC-A Type-2	SMD type	I2C	Antenna	
		1	SPI	512KB Flash	
				64KB RAM	
			12S		
			I2S PDM		
			PDM	32kHz Crystal	
				32kHz Crystal FCC/ISED/Japan certified	
EYSHCNZWZ (nRF52832)			PDM	32kHz Crystal FCC/ISED/Japan certified Complies with standards required by RED	
			PDM	32kHz Crystal FCC/ISED/Japan certified	

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Part number	Function	Module type	I/F	Feature	Outline [mm] (Height : Maximum)
EYSHJNZWZ	Bluetooth® low energy v5.0	BLE Central and Peripheral	UART	w/CPU (Cortex M4F)	5.1 x 11.3 x 1.3
(nRF52832)	& NFC-A Type-2	SMD type	I2C	Antenna	
			SPI	512KB Flash	
			I2S	64KB RAM	
			PDM	FCC/ISED/Japan certified	
			15 GPIO	Complies with standards required by RED (2014/53/EU)	
				ETSI EN 300 328 v2.2.2 Conducted Test	
EYSHSNZWZ	Bluetooth® low energy v5.0	BLE Central and Peripheral	UART	Report Available w/CPU (Cortex M4F)	3.25 x 8.55 x 0.85
(nRF52832)	& NFC-A Type-2	SMD type	I2C	Antenna	3.23 x 8.33 x 0.83
			SPI	512KB Flash	
			I2S	64KB RAM	
			PDM	FCC/ISED/Japan certified	
			15 GPIO	Complies with standards required by RED	
				(2014/53/EU) ETSI EN 300 328 v2.2.2 Conducted Test	
				Report Available	
EYSRCNZUY	Bluetooth® low energy v5.3	BLE Central and Peripheral	UART	w/CPU (Cortex M4)	9.6 x 12.9 x 2.0
(nRF52820)	& 802.15.4 (Thread)	SMD type	USB I2C	32kHz Crystal Antenna	
			SPI	256KB Flash	
			PDM	32KB RAM	
			16 GPIO	FCC/ISED/Japan certified ETSI EN 300 328 v2.2.2 Conducted Test	0
				Report Available	
				Operation temperature:-40°C~105°C	
EYSRSNZUY (nRF52820)	Bluetooth® low energy v5.3 & 802.15.4 (Thread)	BLE Central and Peripheral SMD type	UART USB	w/CPU (Cortex M4) Antenna	3.25 × 8.55 × 1.00
(1111 02020)	d 002.10.4 (1116ad)	SIMD LYPE	I2C	256KB Flash	
			SPI	32KB RAM	
			PDM 12 GPIO	FCC/ISED/Japan certified ETSI EN 300 328 v2.2.2 Conducted Test	
			12 GFIO	Report Available	
				Operation temperature: $-40^{\circ}C \sim 105^{\circ}C$	
EYSNCNZWW	Bluetooth® low energy v5.2	BLE Central and Peripheral	UART	w/CPU (Cortex M4)	9.6 x 12.9 x 2.0
(nRF52811)	& 802.15.4 (Thread)	SMD type	I2C	Antenna	
			SPI	192KB Flash	
			PDM 30 GPIO	24KB RAM 32kHz Crystal	
			30 GF10	FCC/ISED/Japan certified	
				ETSI EN 300 328 v2.2.2 Conducted Test	
EYSNSNZWW	Bluetooth® low energy v5.2	BLE Central and Peripheral	UART	Report Available w/CPU (Cortex M4)	3.25 x 8.55 x 1.00
(nRF52811)	& 802.15.4 (Thread)	SMD type	I2C	Antenna	3.20 × 8.30 × 1.00
			SPI	192KB Flash	
			PDM 15 GPIO	24KB RAM FCC/ISED/Japan certified	
				ETSI EN 300 328 v2.2.2 Conducted Test	
			LLADT	Report Available	
EYSLCNZWW (nRF52810)	Bluetooth® low energy v5.0 (2Mbps Data Rate support)	BLE Central and Peripheral SMD type	UART I2C	w/CPU(Cortex M4) Antenna	9.6 x 12.9 x 2.0
(11(1) 52010)	(Zimps Data Nate support)	SIMD type	SPI	192KB Flash	
			PDM	24KB RAM	
			00 a. 10	FCC/ISED/Japan certified	
				ETSI EN 300 328 v2.2.2 Conducted Test	
EYSLSNZWW	Bluataath® low aparmy v50	BLE Control and Paripharal	UART	Report Available w/CPU (Cortex M4)	3.25 x 8.55 x 1.00
(nRF52810)	Bluetooth® low energy v5.0 (2Mbps Data Rate support)	BLE Central and Peripheral SMD type	UART I2C	W/CPU (Cortex M4) Antenna	0.20 X 0.00 X 1.00
(ond type	SPI	192KB Flash	
			PDM	24KB RAM	
	1		15 GPIO	FCC/ISED/Japan certified	
	1		1	ETSI EN 300 328 v2.2.2 Conducted Test	
EYSGCNAWY-VX	Bluetooth® low energy v4.2	BLE Central and Peripheral	UART	Report Available w/CPU (Cortex M0)	9.6 x 12.9 x 2.0
(nRF51822)	Didecoours low energy V4.2	SMD type	0AIL1	Antenna	
(TAIYO YUDEN Software Embedded		32kHz Crystal	
				FCC/ISED/Japan certified	
				ETSI EN 300 328 v2.2.2 Conducted Test	
				Report Available	
EYSGJNAWY-VX	Bluetooth® low energy v4.2	BLE Central and Peripheral	UART	w/CPU (Cortex M0)	5.1 x 11.3 x 1.3
(nRF51822)		SMD type		Antenna	
		TAIYO YUDEN Software Embedded		FCC/ISED/Japan certified	
	1			ETSI EN 300 328 v2.2.2 Conducted Test	
				Report Available	
EV(000)17118 (
EYSGCNZWY	Bluetooth® low energy v4.2 (*)	BLE Central and Peripheral	UART	w/CPU (Cortex M0)	9.6 × 12.9 × 2.0
(nRF51822)	1	SMD type	I2C SPI	Antenna 256KB Electr	
	1		SPI 29 GPIO	256KB Flash 32KB RAM	
	1		29 GPIO		
	1			32kHz Crystal FCC/ISED/Japan certified	
				1 00, IOLD/ Dapan odfulleu	
				ETSI EN 300 328 v2.2.2 Conducted Test	

(*) Supported by S130

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Part number	Function	Module type	I/F	Feature	Outline [mm] (Height : Maximum)
EYSGCNZXX	Bluetooth® low energy v4.2 (*)	BLE Central and Peripheral	UART	w/CPU (Cortex M0)	9.6 x 12.9 x 2.0
(nRF51822)		SMD type	I2C	Antenna	
			SPI	256KB Flash	
			29 GPIO	16KB RAM	
				32kHz Crystal	
				FCC/ISED/Japan certified	
				ETSI EN 300 328 v2.2.2 Conducted Test	
				Report Available	
EYSGJNZWY	Bluetooth® low energy v4.2 (*)	BLE Central and Peripheral	UART	w/CPU (Cortex M0)	5.1 x 11.3 x 1.3
(nRF51822)		SMD type	I2C	Antenna	r r r
			SPI	256KB Flash	
			14 GPIO	32KB RAM	
				FCC/ISED/Japan certified	
				ETSI EN 300 328 v2.2.2 Conducted Test	
				Report Available	
EYSGJNZXX	Bluetooth® low energy v4.2 (*)	BLE Central and Peripheral	UART	w/CPU (Cortex M0)	5.1 x 11.3 x 1.3
(nRF51822)		SMD type	I2C	Antenna	r el
			SPI	256KB Flash	
			14 GPIO	16KB RAM	
				FCC/ISED/Japan certified	87 51
				ETSI EN 300 328 v2.2.2 Conducted Test	
				Report Available	
EYAGJNZXX	Bluetooth® low energy v4.2	BLE Peripheral	UART	w/CPU (Cortex M0)	5.1 x 11.3 x 1.3
(nRF51422)	& ANT	SMD type	I2C	Antenna	r m fi
			SPI	256KB Flash	
			14 GPIO	32KB RAM	
				FCC/ISED/Japan certified	
				ETSI EN 300 328 v2.2.2 Conducted Test	
5/000001/0/			UL DT	Report Available	10.0 15.1 0.0
EYSGCCAXW	Bluetooth® Classic & low energy v5.0	BLE Central and Peripheral	UART	Integrated System Clock	10.0 x 15.4 x 2.0
(CSRB5348)		HCI Firmware		Antenna	
		SMD type		FCC/ISED/Japan certified	
				ETSI EN 300 328 v2.2.2 Conducted Test	
				Report Available	
EV00000VW			LICE		
EYSGCCSXW	Bluetooth® Classic & low energy v5.0	BLE Central and Peripheral	USB	Integrated System Clock	10.0 x 15.4 x 2.0
(CSRB5348)		HCI Firmware		Antenna	
		SMD type		FCC/ISED/Japan certified	
				ETSI EN 300 328 v2.2.2 Conducted Test	
				Report Available	
	(*) Supported by S130				

WLAN + MCU Module

Part number	Function	Module type	I/F	Feature	Outline [mm] (Height : Maximum)
WYSACVLAY-XZ	IEEE802.11b/g/n	SMD type	UART	Integrated System Clock	14.0 x 21.4 x 2.4
			SPI	Antenna	
				Support Micro AP	
				FCC/ISED/Japan certified	8
				ETSI EN 300 328 v2.2.2 Conducted Test	•
				Report Available	
				W/CPU (Cortex M4F)	

Part number	Function	Module type	I/F	Feature	Outline [mm] (Height : Maximum)
WYSAGVDXG	IEEE802.11ac/a/b/g/n+ <i>Bluetooth</i> ® 4.2	SMD type	SDIO	Integrated System Clock	11.5 x 24.0 x 2.0
	(Chip antenna Type)		PCM	2.4GHz & 5GHz	
				11ac(VHT80)	
				Dual Band compatible Chip Antenna	
				FCC/ISED/Japan certified	
				ETSI EN 300 328 v2.2.2 Conducted Test	
				Report Available	
				ETSI EN 301 893 v2.1.1 Conducted Test Report Available	
WYSEGVDXG	IEEE802.11ac/a/b/g/n+ <i>Bluetooth</i> ® 4.2	SMD type	SDIO	Integrated System Clock	11.5 x 24.0 x 2.0
	(RF connector Type)		PCM	2.4GHz & 5GHz	
				11ac(VHT80)	
				U.FL connector for external antenna	
				FCC/ISED/Japan certified	
VYSBHVGXG	IEEE802.11ac/a/b/g/n+ <i>Bluetooth</i> ® 4.2	SMD type	SDIO	Integrated System Clock	8.9 x 12.6 x 1.9
	-		PCM	2.4GHz & 5GHz	
				11ac(VHT80)	

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/). CATALOG 2022

